

12500 TI Boulevard, MS 8640, Dallas, Texas 75243

Notification# 20160419001 Datasheet for LM3263 Information Only

Date: 5/24/2016

To: Newark/Farnell PCN

Dear Customer:

This is an information-only announcement of a change to a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN www admin team@list.ti.com).

Sincerely,

PCN Team SC Business Services

Information Only Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE LM3263TME/NOPB

CUSTOMER PART NUMBER

null

Technical details of this Product Change follow on the next page(s).

PCN Number:		20160419001				PCN Date		te:	5/24/2016	
Title	e: Datasheet fo	r LM3263				<u> </u>				
Customer Contact:		PCN Manager					Dept:		Quality Services	
Cha	inge Type:					_				
	Assembly Site		Design Wafer Bump S				p Site			
	Assembly Process		\boxtimes	Data Sheet			Wafer	r Bump Material		
	Assembly Materials			Part number change				p Process		
Щ	Mechanical Specification		Щ	Test Site		Щ		fer Fab Site		
Ш	Packing/Shipping/Labeling			Test Process		4		er Fab Materials		
ļ			<u> </u>	☐ Wafer Fab Process			rocess			
Notification Details										
Description of Change:										
Texas Instruments Incorporated is announcing an information only notification.										
The product datasheet(s) is being updated as summarized below.										
The	following change h	nistory provid	les f	further details.						
TEXAS INSTRUMENTS LM3263 SNVS837B – JUNE 2013 – REVISED APRIL 2016										
Cha	anges from Revision A (August 2013) to	Revis	sion B					Page	
 Added Device Information and Pin Configuration and Functions sections, ESD Ratings and Feature Description, Device Functional Modes, Application and Implementation, Power Supply Recommendations, Layout, Device and Documentation Support, and Mechanical, Packaging, and Orderable Information sections										
The datasheet number will be changed Device Family			ging	Change From:			Chang		go To:	
LM3263				SNVS837A					5837B	
These changes may be reviewed at the datasheet links provided. http://www.ti.com/product/LM3263										
Reason for Change:										
To more accurately reflect device characteristics.										
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative): No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.										
Changes to product identification resulting from this PCN:										
None.										
Product Affected:										
	LM3263TME/NOPB LM3263TMX/NOPB									

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com